



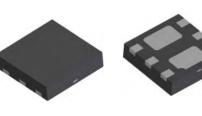
BAV99BRLP SURFACE MOUNT SWITCHING DIODE ARRAY

Features

- Fast Switching Speed
- Low Profile DFN Package (0.575mm typical thickness) is Much Thinner than Conventional SOT Style Packages
- Thermally Efficient DFN Package Features 500mW Power Dissipation Capability in a Compact 2.0 * 2.0mm Footprint
- Two "BAV99" Circuits In One Package
- Lead Free/RoHS Compliant (Note 1)
- "Green" Device (Note 2)

Mechanical Data

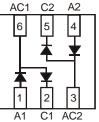
- Case: DFN2020B-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.006 grams (approximate)



DFN2020B-6

Top View

Bottom View



Top View Internal Schematic

Pin 1 = A1 (anode 1, right below the notch indication)
Pin 2 = C1 (cathode 1)
Pin 3 = AC2 (internally connected to rectangular pad)
Pin 4 = A2 (anode 2)
Pin 5 = C2 (cathode 2)
Pin 6 = AC1 (internally connected to the pad with a notch)

Ordering Information (Note 3)

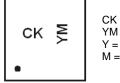
Part Number	Case	Packaging
BAV99BRLP-7	DFN2020B-6	3000/Tape & Reel

Notes: 1. No purposefully added lead.

2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.

3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



CK = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011) M = Month (ex: 9 = September)

Date Code Key

Year	201 [•]	1	2012		2013	20	14	2015		2016	2	2017
Code	Y		Z		А	E	3	С		D		E
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D



Maximum Ratings $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	Value	Unit	
Non-Repetitive Peak Reverse Voltage		V _{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	75	V
RMS Reverse Voltage		V _{R(RMS)}	53	V
Forward Continuous Current (Note 4)		I _{FM}	300	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0µs @ t = 1.0ms @ t = 1.0s	I _{FSM}	3.0 2.0 0.5	A

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 4)	PD	500	mW
Thermal Resistance Junction to Ambient Air	(Note 4)	$R_{ ext{ heta}JA}$	250	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

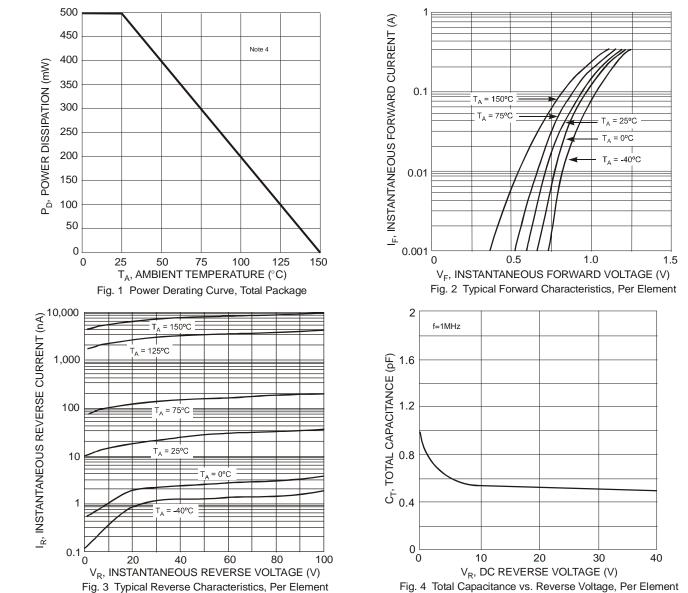
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	V _{(BR)R}	75		V	$I_R = 2.5 \mu A$
Forward Voltage	VF	_	0.715 0.855 1.0 1.25	V	$I_{F} = 1.0mA$ $I_{F} = 10mA$ $I_{F} = 50mA$ $I_{F} = 150mA$
Reverse Current (Note 5)	I _R	_	2.5 50 30 25	μΑ μΑ μΑ nA	$V_{R} = 75V V_{R} = 75V, T_{J} = 150^{\circ}C V_{R} = 20V, T_{J} = 150^{\circ}C V_{R} = 20V$
Total Capacitance	CT	_	2.0	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{rr}	_	4.0	ns	$I_{F} = I_{R} = 10 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_{R}, R_{L} = 100 \Omega$

 Device mounted on FR-4 PCB, on minimum recommended, 2oz copper pad layout.
 Short duration pulse test used to minimize self-heating effect. Notes:

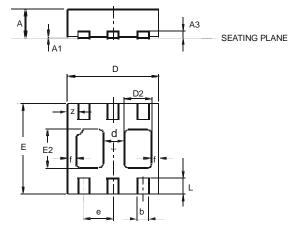
BAV99BRLP



NEW PRODUCT



Package Outline Dimensions



A1	0	0.05	0.02
A3	_	_	0.13
b	0.20	0.30	0.25
D	1.95	2.075	2.00
d			0.45
D2	0.50	0.70	0.60
е	_	-	0.65
Е	1.95	2.075	2.00
E2	0.90	1.10	1.00
f	_	-	0.15
L	0.25	0.35	0.30
z	_	_	0.225
All	Dimens	ions in	mm

Dim

А

DFN2020B-6

Max

0.605

Тур

0.575

Min

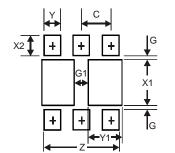
0.545

Bottom View

BAV99BRLP Document number: DS35317 Rev. 4 - 2 Downloaded from Arrow.com.



Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.67
G	0.20
G1	0.40
X1	1.0
X2	0.45
Y	0.37
Y1	0.70
С	0.65

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